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- 2-V to 5.5-V V_{CC} Operation
- Max t_{pd} of 7 ns at 5 V
- Typical V_{OLP} (Output Ground Bounce)
 <0.8 V at V_{CC} = 3.3 V, T_A = 25°C
- Typical V_{OHV} (Output V_{OH} Undershoot)
 >2.3 V at V_{CC} = 3.3 V, T_A = 25°C
- Support Mixed-Mode Voltage Operation on All Ports
- I_{off} Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

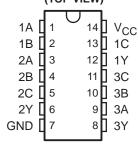
description/ordering information

These triple 3-input positive-AND gates are designed for 2-V to 5.5-V V_{CC} operation.

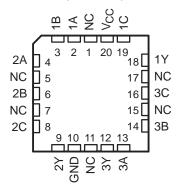
The 'LV11A devices perform the Boolean function $Y = A \bullet B \bullet C$ or $Y = \overline{A} + \overline{B} + \overline{C}$ in positive logic.

These devices are fully specified for partial-power-down applications using $I_{\rm off}$. The $I_{\rm off}$ circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down.

SN54LV11A . . . J OR W PACKAGE SN74LV11A . . . D, DB, DGV, NS, OR PW PACKAGE (TOP VIEW)



SN54LV11A . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

ORDERING INFORMATION

TA	PACKAGE† SOIC - D Tube of 50 Reel of 2500 SOP - NS Reel of 2000		ORDERABLE PART NUMBER	TOP-SIDE MARKING
	0010 D	Tube of 50	SN74LV11AD	11/44 A
	SOIC - D	Reel of 2500	SN74LV11ADR	LV11A
	SOP – NS	Reel of 2000	SN74LV11ANSR	74LV11A
4000 to 0500	SSOP – DB	Reel of 2000	SN74LV11ADBR	LV11A
-40°C to 85°C		Tube of 90	SN74LV11APW	
	TSSOP - PW	Reel of 2000	SN74LV11APWR	LV11A
		Reel of 250	SN74LV11APWT	
	TVSOP - DGV	Reel of 2000	SN74LV11ADGVR	LV11A
	CDIP – J	Tube of 25	SNJ54LV11AJ	SNJ54LV11AJ
-55°C to 125°C	CFP – W	Tube of 150	SNJ54LV11AW	SNJ54LV11AW
	LCCC - FK	Tube of 55	SNJ54LV11AFK	SNJ54LV11AFK

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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FUNCTION TABLE (each gate)

	INPUTS	OUTPUT	
Α	В	С	Y
Н	Н	Н	Н
L	X	Χ	L
Х	L	Χ	L
Х	Χ	L	L

logic diagram, each gate (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}		–0.5 V to 7 V
Input voltage range, V _I (see Note 1)		
Output voltage range applied in high or low sta	te, VO (see Notes 1 and 2)	
Voltage range applied to any output in the power	er-off state, V _O (see Note 1)	–0.5 V to 7 V
Input clamp current, I _{IK} (V _I < 0)		–20 mA
Output clamp current, I _{OK} (V _O < 0)		–50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})		±25 mA
Continuous current through V _{CC} or GND		±50 mA
Package thermal impedance, θ _{JA} (see Note 3)	: D package	86°C/W
	DB package	96°C/W
	DGV package	127°C/W
	NS package	76°C/W
	PW package	113°C/W
Storage temperature range, T _{sta}		

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

- 2. This value is limited to 5.5 V maximum.
- 3. The package thermal impedance is calculated in accordance with JESD 51-7.



recommended operating conditions (see Note 4)

			SN54L\	/11A	SN74L	V11A	
			MIN	MAX	MIN	MAX	UNIT
Vcc	Supply voltage		2	5.5	2	5.5	V
		V _{CC} = 2 V	1.5		1.5		
\/	High level innerticate as	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	V _{CC} ×0.7		$V_{CC} \times 0.7$		V
V_{IH}	High-level input voltage	$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$	$V_{CC} \times 0.7$		$V_{CC} \times 0.7$		V
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	$V_{CC} \times 0.7$		$V_{CC} \times 0.7$		
		V _{CC} = 2 V		0.5		0.5	
V	Low lovel input veltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	V	$CC \times 0.3$	V	CC × 0.3	V
V_{IL}	Low-level input voltage	$V_{CC} = 3 V \text{ to } 3.6 V$	V	$CC \times 0.3$	V	CC×0.3	V
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		$C \times 0.3$	V _{CC} ×0		
VI	Input voltage		0,0	5.5	0	5.5	V
VO	Output voltage		0	VCC	0	VCC	V
		V _{CC} = 2 V	N. C.	-50		-50	μΑ
la	High lovel output ourrent	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		-2		-2	
ЮН	High-level output current	$V_{CC} = 3 V \text{ to } 3.6 V$		-6		-6	mA
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		-12		-12	
		$V_{CC} = 2 V$		50		50	μΑ
la.	Low lovel output ourrent	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		2		2	
lol	Low-level output current	$V_{CC} = 3 V \text{ to } 3.6 V$		6		6	mA
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		12		12	
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		200		200	
$\Delta t/\Delta v$	Input transition rise or fall rate	$V_{CC} = 3 V \text{ to } 3.6 V$		100		100	ns/V
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		20		20	
T_A	Operating free-air temperature		-55	125	-40	85	°C

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	TOT COMPLETIONS	T	SN54LV11A	SN74LV11A	
PARAMETER	TEST CONDITIONS	VCC	MIN TYP MAX	MIN TYP MAX	UNIT
	I _{OH} = -50 μA	2 V to 5.5 V	V _{CC} -0.1	V _{CC} -0.1	
.,	$I_{OH} = -2 \text{ mA}$	2.3 V	2	2	.,
VOH	$I_{OH} = -6 \text{ mA}$	3 V	2.48	2.48	V
	I _{OH} = -12 mA	4.5 V	3.8	3.8	
	I _{OL} = 50 μA	2 V to 5.5 V	0.1	0.1	
V	I _{OL} = 2 mA	2.3 V	0.4	0.4	V
V _{OL}	I _{OL} = 6 mA	3 V	0.44	0.44	V
	I _{OL} = 12 mA	4.5 V	0.55	0.55	
lį	V _I = 5.5 V or GND	0 to 5.5 V	±1	±1	μΑ
ICC	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V	20	20	μΑ
l _{off}	V_I or $V_O = 0$ to 5.5 V	0 V	5	5	μΑ
Ci	V _I = V _{CC} or GND	3.3 V	1.9	1.9	pF

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switching characteristics over recommended operating free-air temperature range, V_{CC} = 2.5 V \pm 0.2 V (unless otherwise noted) (see Figure 1)

242445	FROM	то	LOAD	T,	4 = 25°C	;	SN54LV11A	SN74L	V11A	
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN MAX	MIN	MAX	UNIT
^t pd	A, B, or C	Υ	C _L = 15 pF		6.9*	13.8*	1 16*	1	16	ns
t _{pd}	A, B, or C	Y	C _L = 50 pF		9.9	17.5	1 21	1	21	ns

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

DADAMETED	FROM	то	LOAD	T,	4 = 25°C	;	SN54LV11A	SN74L	.V11A	LINUT
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN MAX	MIN	MAX	UNIT
^t pd	A, B, or C	Υ	C _L = 15 pF		5.2*	8.8*	13 10.5*	1	10.5	ns
t _{pd}	A, B, or C	Y	C _L = 50 pF		7.2	12.3	1 14	1	14	ns

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

DADAMETER	FROM	то	LOAD	T,	4 = 25°C	;	SN54LV11A	SN74L	.V11A	
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN MAX	MIN	MAX	UNIT
t _{pd}	A, B, or C	Υ	C _L = 15 pF		3.9*	5.9*	10 7*	1	7	ns
t _{pd}	A, B, or C	Y	C _L = 50 pF		5.4	7.9	1 9	1	9	ns

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.

noise characteristics, $V_{CC} = 3.3 \text{ V}$, $C_L = 50 \text{ pF}$, $T_A = 25^{\circ}\text{C}$ (see Note 5)

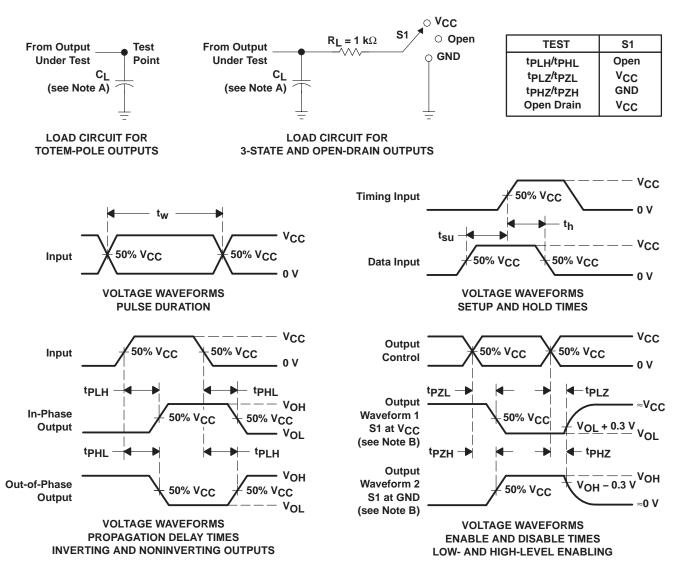
	PARAMETER Quiet output, maximum dynamic V _{OL} Quiet output, minimum dynamic V _{OL} Quiet output, minimum dynamic V _{OH} High-level dynamic input voltage	SN			
	PARAMETER	MIN	TYP	MAX	UNIT
VOL(P)	Quiet output, maximum dynamic V _{OL}		0.2	0.8	V
V _{OL(V)}	Quiet output, minimum dynamic V _{OL}		0	-0.8	V
VOH(V)	Quiet output, minimum dynamic VOH		3.2		V
VIH(D)	High-level dynamic input voltage	2.31			V
V _{IL(D)}	Low-level dynamic input voltage			0.99	V

NOTE 5: Characteristics are for surface-mount packages only.

operating characteristics, T_A = 25°C

	PARAMETER		TEST CO	VCC	TYP	UNIT	
		Device discination considered	O. 50 F	4 40 MH-	3.3 V	13.9	. [
1	pd	Power dissipation capacitance	$C_L = 50 pF$,	f = 10 MHz	5 V	15.4	pF

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_Q = 50 \Omega$, $t_f \leq 3$ ns, $t_f \leq 3$ ns.
- D. The outputs are measured one at a time, with one input transition per measurement.
- E. tpLZ and tpHZ are the same as tdis.
- F. tpzi and tpzH are the same as ten.
- G. tpHL and tpLH are the same as tpd.
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms



DGV (R-PDSO-G**)

24 PINS SHOWN

PLASTIC SMALL-OUTLINE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

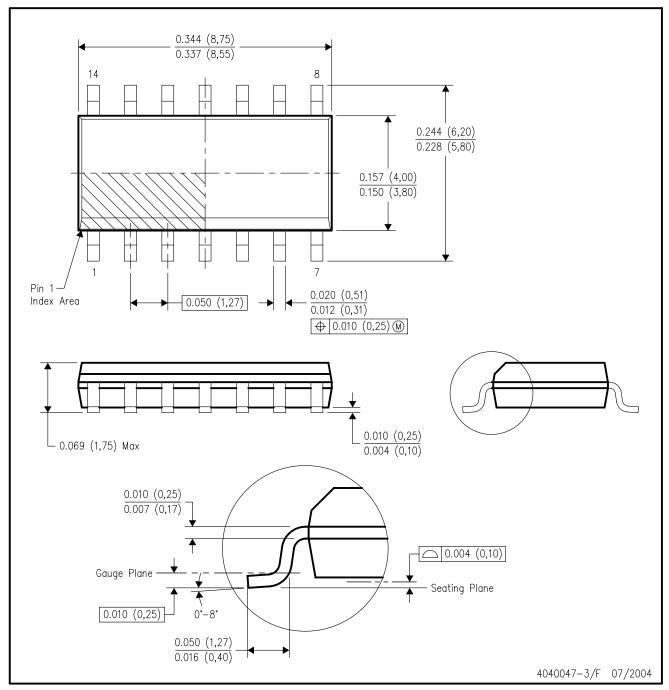
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194



D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AB.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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